

## **ABSTRACT OF THE DISCLOSURE**

### **STRUCTURE HAVING FLUSH CIRCUITRY FEATURES AND METHOD OF MAKING**

5 Embedded flush circuitry features are provided by providing a carrier foil having an electrically conductive layer therein and coating the electrically conductive layer with a dielectric material. Circuitry features are formed in the dielectric material and conductive metal is plated to fill the circuitry features.

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